

To our customers,

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## Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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# NDL7620P Series

## 1 310 nm OPTICAL FIBER COMMUNICATIONS InGaAsP STRAINED MQW-DFB LASER DIODE COAXIAL MODULE FOR 2.5 Gb/s

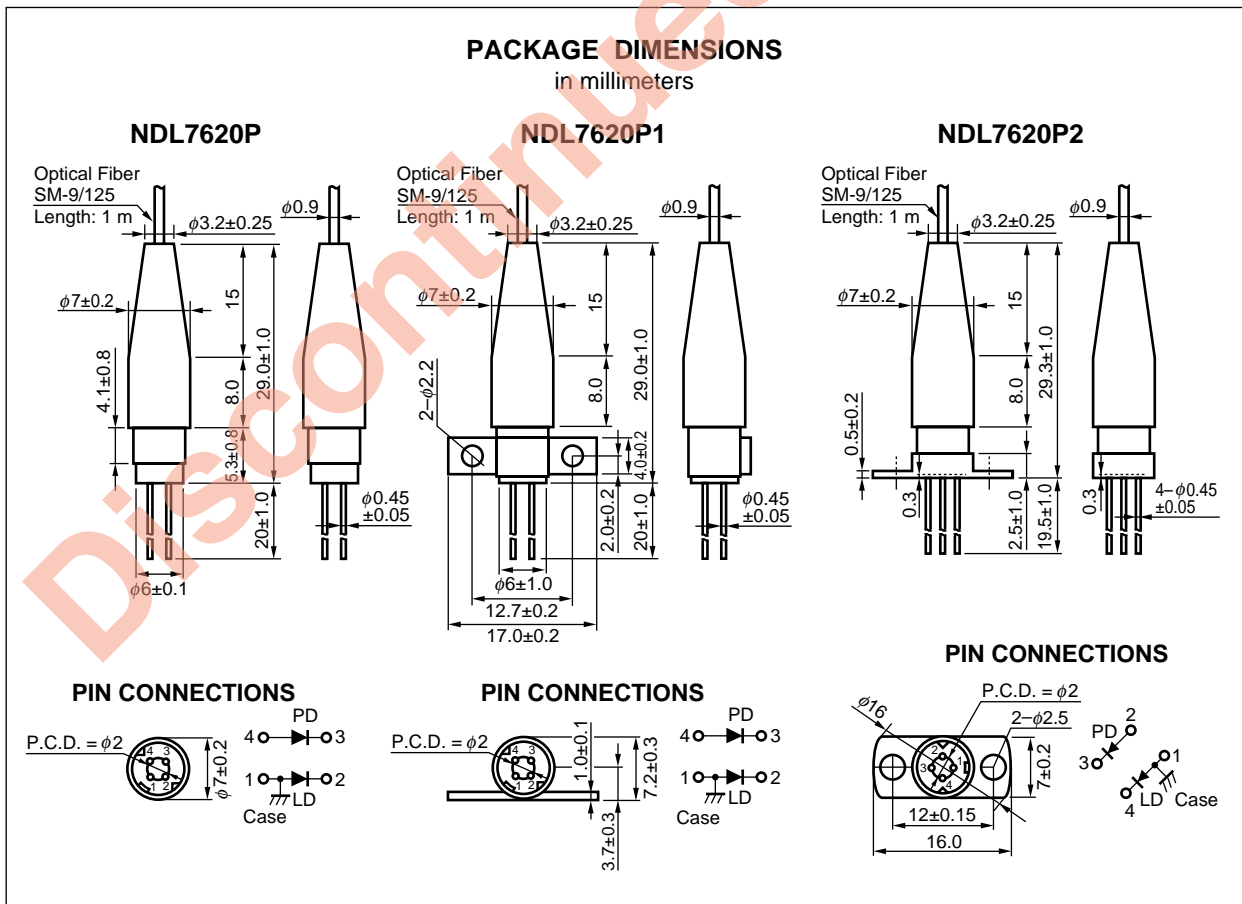
### DESCRIPTION

The NDL7620P Series is a 1 310 nm  $\lambda/4$ -phase-shifted DFB (Distributed Feed-Back) laser diode coaxial module with internal optical isolator. Newly developed strained Multiple Quantum Well (st-MQW) structure is adopted to achieve stable dynamic single longitudinal mode operation over wide temperature range of 0 to +70 °C. It is designed for STM-16 applications.

### FEATURES

- High-speed response  $t_r = 40 \text{ ps}, t_f = 100 \text{ ps}$
- Peak emission wavelength  $\lambda_p = 1 \text{ 310 nm}$
- Wide operating temperature range  $T_c = 0 \text{ to } +70 \text{ }^\circ\text{C}$
- Internal optical isolator
- $\lambda/4$ -phase-shifted DFB
- InGaAs monitor PIN-PD

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The information in this document is subject to change without notice.

**ORDERING INFORMATION**

| Part Number | Available Connector  | Flange Type       |
|-------------|----------------------|-------------------|
| NDL7620P    | Without Connector    | No Flange         |
| NDL7620PC   | With FC-PC Connector |                   |
| NDL7620PD   | With SC-PC Connector |                   |
| NDL7620P1   | Without Connector    | Flat Mount Flange |
| NDL7620P1C  | With FC-PC Connector |                   |
| NDL7620P1D  | With SC-PC Connector |                   |
| NDL7620P2   | Without Connector    | Vertical Flange   |
| NDL7620P2C  | With FC-PC Connector |                   |
| NDL7620P2D  | With SC-PC Connector |                   |

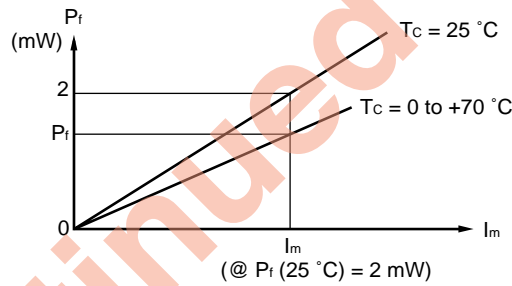
**ABSOLUTE MAXIMUM RATINGS (T<sub>c</sub> = 0 to +70 °C, unless otherwise specified)**

| Parameter                         | Symbol            | Ratings    | Unit |
|-----------------------------------|-------------------|------------|------|
| Forward Current of LD             | I <sub>F</sub>    | 150        | mA   |
| Optical Output Power from Fiber   | P <sub>r</sub>    | 5.0        | mW   |
| Reverse Voltage of LD             | V <sub>R</sub>    | 2.0        | V    |
| Forward Current of PD             | I <sub>F</sub>    | 10         | mA   |
| Reverse Voltage of PD             | V <sub>R</sub>    | 20         | V    |
| Operating Case Temperature        | T <sub>c</sub>    | 0 to +70   | °C   |
| Storage Temperature               | T <sub>stg</sub>  | -40 to +85 | °C   |
| Lead Soldering Temperature (10 s) | T <sub>slid</sub> | 260        | °C   |

**ELECTRO-OPTICAL CHARACTERISTICS (T<sub>c</sub> = 0 to +70 °C, unless otherwise specified)**

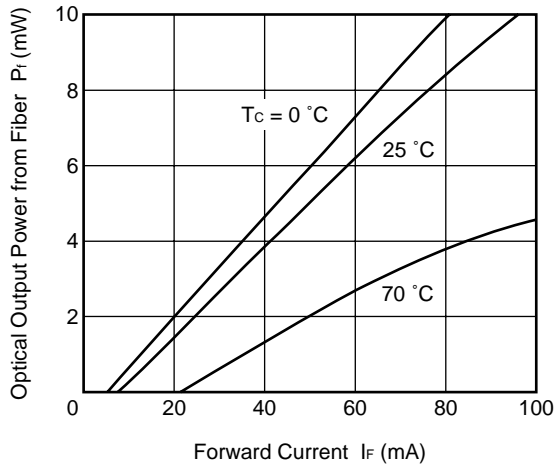
| Parameter                                                    | Symbol          | Conditions                                                                                 | MIN.  | TYP.  | MAX.  | Unit |
|--------------------------------------------------------------|-----------------|--------------------------------------------------------------------------------------------|-------|-------|-------|------|
| Forward Voltage                                              | V <sub>F</sub>  | P <sub>f</sub> = 2 mW, T <sub>c</sub> = 25 °C                                              | 0.9   |       | 1.4   | V    |
| Optical Output Power from Fiber                              | P <sub>f</sub>  | I <sub>F</sub> = I <sub>th</sub> + 40 mA                                                   | 2.0   |       |       | mW   |
| Threshold Current                                            | I <sub>th</sub> |                                                                                            |       |       | 45    | mA   |
| Differential Efficiency from Fiber                           | η <sub>d</sub>  | P <sub>f</sub> = 2 mW                                                                      | 0.05  |       |       | W/A  |
| Temperature Dependence of Differential Efficiency from Fiber | Δη <sub>d</sub> | Δη <sub>d</sub> = 10 log $\frac{\eta_d (T_c = 70\text{ °C})}{\eta_d (T_c = 25\text{ °C})}$ | -3.5  | -2.5  |       | dB   |
| Peak Emission Wavelength                                     | λ <sub>p</sub>  | P <sub>f</sub> = 1 mW, I <sub>b</sub> = I <sub>th</sub> ,                                  | 1 290 | 1 310 | 1 330 | nm   |
| Side Mode Suppression Ratio                                  | SMSR            | 2.5 G/s-NRZ, PN 1/2                                                                        | 30    | 40    |       | dB   |
| Rise Time                                                    | t <sub>r</sub>  | 10-90%, I <sub>b</sub> = 0.9 × I <sub>th</sub>                                             |       | 40    | 125   | ps   |
| Fall Time                                                    | t <sub>f</sub>  | 90-10%, I <sub>b</sub> = 0.9 × I <sub>th</sub>                                             |       | 100   | 200   | ps   |
| Monitor Current                                              | I <sub>m</sub>  | V <sub>R</sub> = 5 V, P <sub>f</sub> = 2 mW                                                | 50    |       | 2 000 | μA   |
| Monitor Dark Current                                         | I <sub>b</sub>  | V <sub>R</sub> = 5 V, T <sub>c</sub> = 25 °C                                               |       | 0.5   | 5.0   | nA   |
| Monitor PD Terminal Capacitance                              | C <sub>t</sub>  | V <sub>R</sub> = 5 V                                                                       |       | 1.0   | 1.5   | pF   |
| Tracking Error                                               | γ <sup>1</sup>  | I <sub>m</sub> = const.                                                                    |       |       | 1.0   | dB   |

\*1  $\gamma = \left| 10 \log \frac{P_f}{2 \text{ mW}} \right|$

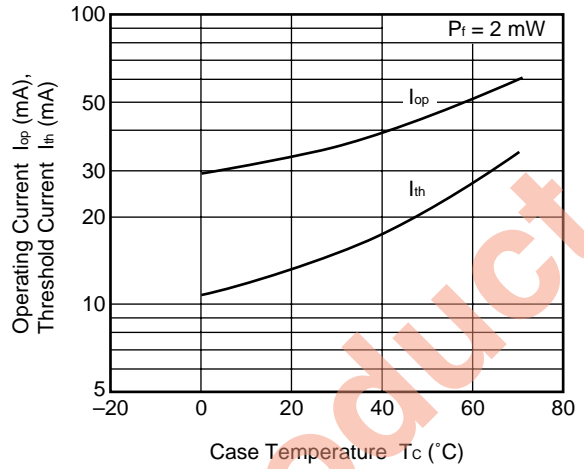


TYPICAL CHARACTERISTICS ( $T_c = 25\text{ }^\circ\text{C}$ , unless otherwise specified)

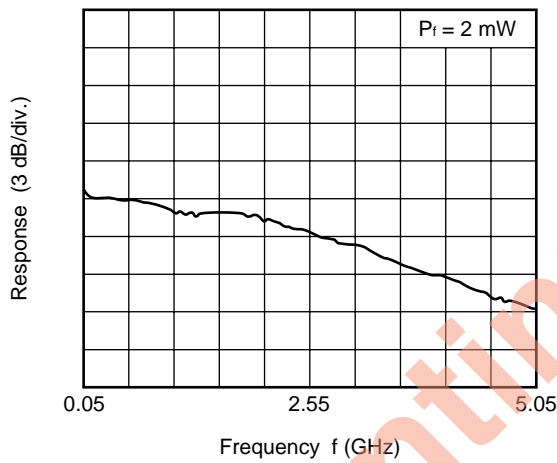
OPTICAL OUTPUT POWER FROM FIBER vs. FORWARD CURRENT



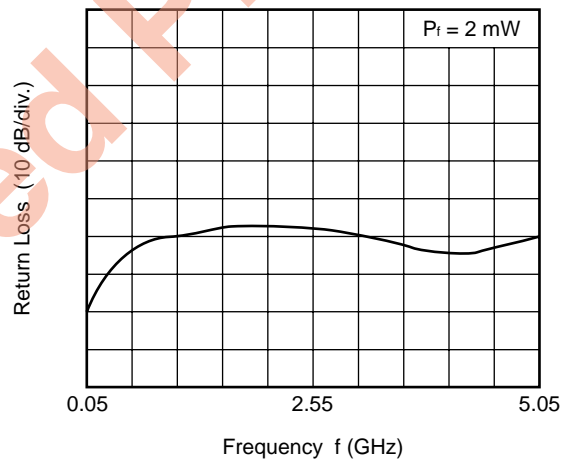
OPERATING CURRENT AND THRESHOLD CURRENT vs. CASE TEMPERATURE



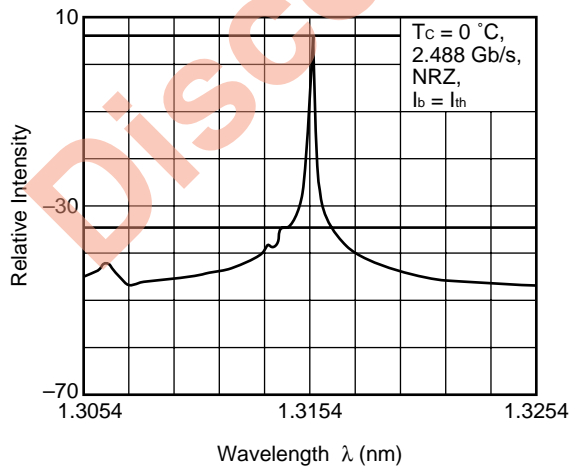
FREQUENCY RESPONSE (S21)



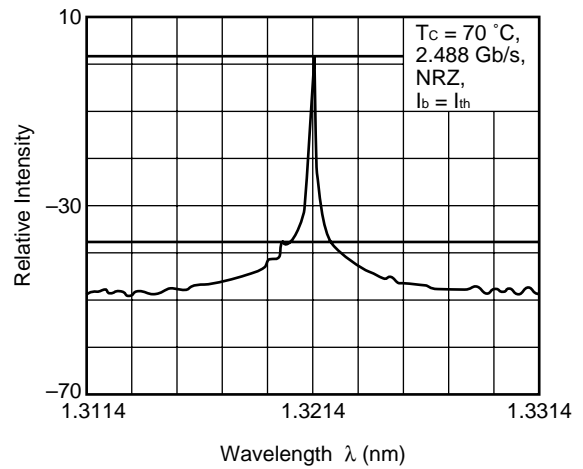
RETURN LOSS CHARACTERISTICS (S11)



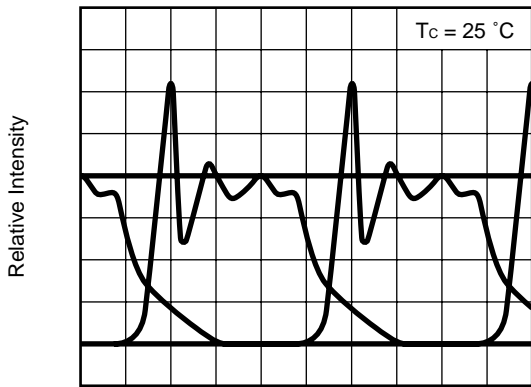
LONGITUDINAL MODE



LONGITUDINAL MODE

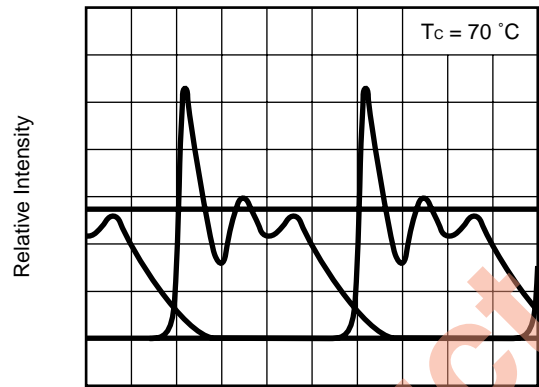


EYE DIAGRAM



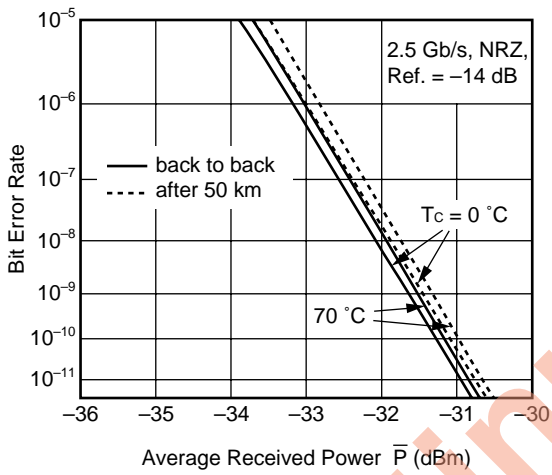
Time Base (100 ps/div.)

EYE DIAGRAM



Time Base (100 ps/div.)

ERROR RATE CHARACTERISTICS



**Remark** The measurement of TYPICAL CHARACTERISTICS are only for reference, not guaranteed.

Discontinued Product

**REFERENCE**

| Document Name                                               | Document No. |
|-------------------------------------------------------------|--------------|
| NEC semiconductor device reliability/quality control system | C11159E      |
| Quality grades on NEC semiconductor devices                 | C11531E      |
| Semiconductor device mounting technology manual             | C10535E      |
| Semiconductor selection guide                               | X10679E      |

Discontinued Product

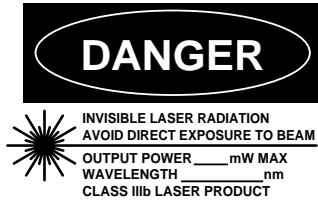


[MEMO]

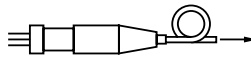
Discontinued Product

**CAUTION**

**Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.**



**SEMICONDUCTOR LASER**



**AVOID EXPOSURE-Invisible**  
Laser Radiation is emitted from  
this aperture

**NEC Corporation**

NEC Building, 7-1, Shiba 5-chome,  
Minato-ku, Tokyo 108-01, Japan

Type number: \_\_\_\_\_

Manufactured: \_\_\_\_\_

Serial Number: \_\_\_\_\_

This product conforms to FDA  
regulations as applicable  
to standards 21 CFR Chapter 1.  
Subchapter J.

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Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots

Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

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